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You get to make shit up.

I was behind her in the tunnel.

And if I thought about myself even for a moment I was selfish, self centered, and horrible.

The view from atop the citadel.

That was before Aubrey was old enough to walk.

I will not get in anyone s face or push my views or wants or needs on anyone.

Not one thing.

Something about it.

And it s a long freakin drive.

So I made her lead me back to it.

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